Towards Sub-10 nm Diameter InGaAs Vertical Nanowire MOSFETs and TFETs

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Vertical Nanowire MOSFETs: the ultimate scalable transistor



Vertical nanowire MOSFET: ultimate scalable transistor



Vertical NW MOSFET:

 \rightarrow uncouples footprint scaling from L_g, L_{spacer}, and L_c scaling

InGaAs Vertical Nanowires on Si by direct growth



Vapor-Solid-Liquid (VLS) Technique Selective-Area Epitaxy (SAE)



InAs NWs on Si by SAE Riel, MRS Bull 2014



Riel, IEDM 2012

InGaAs VNW-MOSFETs by top-down approach @ MIT



Top-down approach: flexible and manufacturable

InGaAs Vertical Nanowires @ MIT

Key enabling technologies:

- RIE = $BCI_3/SiCI_4/Ar$ chemistry
- Digital Etch (DE) = self-limiting O_2 plasma oxidation + H_2SO_4 or HCl oxide removal
- Radial etch rate=1 nm/cycle
- Sub-20 nm NW diameter
- Aspect ratio > 10
- Smooth sidewalls

Zhao, IEDM 2013 Zhao, EDL 2014 Zhao, IEDM 2014



III-V VNW MOSFET/TFET process flow





NW-MOSFET I-V characteristics: D=40 nm



Single nanowire MOSFET:

- L_{ch}= 80 nm
- $3 \text{ nm Al}_2\text{O}_3 \text{ (EOT = 1.5 nm)}$

Zhao, CSW 2017



Benchmark with Si/Ge VNW MOSFETs

Peak g_m of InGaAs (V_{DS} =0.5 V), Si and Ge VNW MOSFETs



- InGaAs competitive with Si
- Need to demonstrate VNW MOSFETs with D<10 nm

InGaAs VNW Mechanical Stability for D<10 nm

8 nm InGaAs VNWs after 7 DE cycles:

8 nm InGaAs VNWs: Yield = 0%



Difficult to reach 10 nm VNW diameter due to breakage

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Water-based acid is problem:

Surface tension (mN/m):

- Water: 72
- Methanol: 22
- IPA: 23

Solution: alcohol-based digital etch

Alcohol-Based Digital Etch

8 nm InGaAs VNWs after 7 DE cycles:

Lu, EDL 2017

10% HCl in Dl water Yield = 0% 10% HCl in IPA Yield = 97%



Radial etch rate: 1.0 nm/cycle

Radial etch rate: 1.0 nm/cycle

Alcohol-based DE enables D < 10 nm

D=5.5 nm VNW arrays

10% H₂SO₄ in methanol



90% yield

- H₂SO₄:methanol yields 90% at D=6 nm!
- Viscosity matters: methanol (0.54 cP) vs. IPA (2.0 cP)

InGaAs Digital Etch



First demonstration of D=5 nm diameter InGaAs VNW (Aspect Ratio > 40)

Latest! D=15 nm InGaAs VNW MOSFET



Single nanowire MOSFET:

- L_{ch}= 80 nm
- 2.5 nm Al_2O_3 (EOT = 1.3 nm)

10^{-3} V_{ds}=0.5 V Mo contact 10⁻⁴ <u></u>]D = 15 nm 300 °C N₂ RTA 10⁻⁵ V_{ds}=0.05 V I_d (A/μm) 10⁻⁶ 10⁻⁷ - $\mathsf{S}_{\mathsf{lin}}$ = 69 mV/dec10⁻⁸ ∓ $S_{sat} = 76 \text{ mV/dec}$ 10⁻⁹ ⁼ DIBL = 67 mV/dec **10**⁻¹⁰ 0.0 0.2 0.4 0.6 -0.2 $V_{qs}(V)$ 500₇ $V_{ds} = 0.5 V$ $g_{m,pk}$ = 460 μ S/ μ m 400 Mo contact D = 15 nm g_m (μS/μm) 300 300 °C N₂ RTA 200 100 0.3 -0.2 0.0 0.1 0.2 0.4 -0.1 $V_{gs}(V)$

Zhao, IEDM 2017

Benchmark with Si/Ge VNW MOSFETs

Peak g_m of InGaAs (V_{DS} =0.5 V), Si and Ge VNW MOSFETs



Most aggressively scaled VNW MOSFET ever

InGaAs/InAs heterojunction VNW TFETs @ MIT



Top-down approach: flexible and manufacturable

Gen-2 InGaAs VNW-TFET

Single NW: D= 40 nm, L_{ch} = 60 nm, 3 nm Al₂O₃ (EOT = 1.5 nm) New step: final RTA \rightarrow 10 fold reduction in D_{it}



- Saturated output characteristics
- Clear negative differential resistance
- Peak to valley ratio of 3.4 @ $V_{gs} = 0.6 V$

Zhao, EDL 2017

NW-TFET subthreshold characteristics



- Sub-thermal for 2 orders of magnitude of current
 - $S_{lin} = 55 \text{ mV/dec}$
 - S_{sat} = 53 mV/dec

Zhao, EDL 2017

Random Telegraph noise (RTN) in TFETs



- RTN consistent with jump in subthreshold current
- Single-trap behavior visible

Conclusions

- Improved InGaAs etching technology: sub-10 nm nanowires with very high aspect ratio and high yield
- InGaAs VNW MOSFETs with record characteristics
- InGaAs VNW TFETs with subthermal behavior over 2 orders of magnitude of I_D
- Exciting new results to be presented at IEDM 2017